

Electrolytic Aluminum Capacitors



EXXELIA

Electrolytic Aluminum Capacitors



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Selection Guide

SCREW TERMINALS

Reference	Capacitance (μ F)	Voltage (V)	Dimensions in mm (inches)		Operating temperature	Main characteristics	Page	
			θ	H				
	FELSIK 85 (BC) - CO 54 FELSIK 85 (BD) - CO 53	68 to 680 000	10 to 630	36 to 90 [1,417 to 3,543] (2,047 to 7,874)	52 to 200	-55°C + 85°C	Standard 85°C	16
	FELSIK 039 (BC) - CO 39 FELSIK 037 (BD) - CO 37	100 to 150 000	10 to 400	36 to 77 [1,417 to 3,031] (1,850 to 5,669)	47 to 144	-55°C + 85°C	Standard C039 type (railway maintenance standard)	22
	FELSIK 85 M (BC) - CO 54 FELSIK 85 M (BD) - CO 53	68 to 330 000	10 to 630	36 to 90 [1,417 to 3,543] (2,047 to 7,874)	52 to 200	-55°C + 85°C	Standard 85°C ±20% tolerance	26
	FELSIK 105 (BC - BD)	100 to 470 000	16 to 450	36 to 90 [1,417 to 3,543] (2,047 to 7,874)	52 to 200	-55°C + 105°C	Extreme Long life	31
	FELSIK 105 TFRS (BC - BD) -CO 45	470 to 68 000	10 to 100	36 to 77 [1,417 to 3,031] (1,850 to 5,669)	47 to 144	-55°C + 105°C	Very low ESR	35
	FELSIK 105 LP (BC)	1 500 to 220 000	10 to 450	90 [3,543]	67 [2,638]	-55°C + 105°C	105 with Low Profile can	38
	FELSIK HC (BC - BD)	100 to 2 200 000	10 to 500	36 to 90 [1,417 to 3,543] (2,047 to 7,874)	52 to 200	-55°C + 85°C	High energy density	40
	FELSIK HV (BC - BD)	1 500 to 47 000	160 to 450	51 to 90 [2,008 to 3,543] (4,094 to 7,874)	104 to 200	-55°C + 105°C	Extreme Long life; High ripple	48
	FELSIK 125 FRS (BC) - CO 47 FELSIK 125 FRS (BD) - CO 46	220 to 150 000	16 to 350	36 to 90 [1,417 to 3,543] (2,087 to 5,709)	53 to 145	-55°C + 125°C	Low ESR	51

RADIAL LEADED

Reference	Capacitance (μ F)	Voltage (V)	Dimensions in mm (inches)				Operating temperature	Main characteristics	Page
			I	L	θ	H			
	ALSiC 145 20G	220 to 3 300	12 to 115		20 25 [0,787] [0,984]	18 22,5 [0,709] [0,886]	-55°C + 145°C	High temperature range - Long life withstand 20g vibrations	56
	ALSiC 20G	100 to 80 000	10 to 500		20 25 [0,787] [0,984]	18 to 35,5 [0,787 to 0,984]	-55°C + 105°C	Withstand 20g vibrations	58
	CUBISiC	100 to 33 000	10 to 450	35 [1,378]	35 to 50 [1,378 to 1,969]	16 [0,630]	-55°C + 105°C	Non cylindrical case, Withstand 20g vibrations, High energy density	61
	CUBISiC LP	120 to 68 000	10 to 400	45 [1,772]	12 [0,472]	35 to 75 [1,378 to 2,953]	-55°C + 105°C	Non cylindrical case, Withstand 20g vibrations, High energy density	64

Selection Guide

SNAP IN

Reference	Capacitance [µF]	Voltage (V)	Dimensions in mm (inches)		Operating temperature	Main characteristics	Page	
			Ø	H				
	SNAPSIC	22 to 47 000	16 to 500	22 to 35 [0,866 to 1,378]	30 to 50 [1,181 to 1,969]	-55°C + 85°C	Standard 85°C type	68
	SNAPSIC 105	22 to 68 000	16 to 500	22 to 35 [0,866 to 1,378]	25 to 50 [0,984 to 1,969]	-55°C + 115°C	Standard 105°C type	72
	SNAPSIC HC	33 to 47 000	25 to 500	22 to 35 [0,866 to 1,378]	25 to 50 [0,984 to 1,969]	-55°C + 85°C	High energy density	76
	SNAPSIC HV	47 to 2 200	16 to 500	22 to 35 [0,866 to 1,378]	25 to 50 [0,984 to 1,969]	-55°C + 105°C	Long Life; High ripple current	83
	SNAPSIC 4P	330 to 150 000	16 to 500	35 to 45 [0,866 to 1,378]	50 to 100 [1,969 to 3,937]	-55°C + 85°C	Standard 85°C type with 4Pins	86
	SNAPSIC 105 4P	330 to 150 000	16 to 500	35 to 45 [0,866 to 1,378]	50 to 100 [1,969 to 3,937]	-55°C + 105°C	Standard 105°C type with 4Pins	90
	SNAPSIC 105 LP	150 to 68 000	16 to 500	45 [1,772]	16 to 40 [0,630 to 1,575]	-55°C + 105°C	Low Profile 105°C with 4 Pins	93
	SNAPSIC 125	470 to 47 000	16 to 100	22 to 35 [0,866 to 1,378]	25 to 50 [0,984 to 1,969]	-55°C + 125°C	High temperature range - Long Life	96

AXIAL LEADED

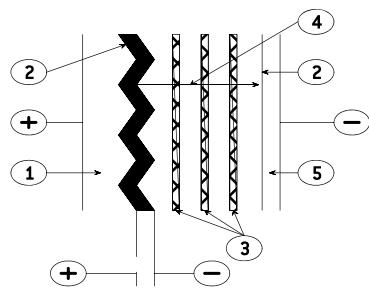
Reference	Capacitance [µF]	Voltage (V)	Dimensions mm (inches)		Operating temperature	Main characteristics	Page	
			Ø	H				
	SICAL SICAL CO 42	2,2 to 47 000	10 to 630	6,5 to 25 [0,256 to 0,984]	15 to 75 [0,591 to 2,953]	-55°C + 85°C	Standard 85°C type	100
	PRORELSIC 125 CO 52	1 to 15 000	10 to 450	6,5 to 25 [0,256 to 0,984]	15 to 75 [0,591 to 2,953]	-55°C + 125°C	125°C Long life	106
	PRORELSIC 145 CO 52	6,8 to 10 000	16 to 450	14 to 25 [0,551 to 0,984]	30 to 75 [1,181 to 2,953]	-55°C + 145°C	High temperature Long life	112
	VACSIC 105	15 to 4 700	10 to 350	12 to 16 [0,472 to 0,630]	30 [1,181]	-55°C + 105°C	Standard 105°C type Withstand 45g vibrations.	116
	VACSIC 150	6,8 to 3 300	16 to 450	12 to 16 [0,472 to 0,630]	30 [1,181]	-55°C + 150°C	High temperature Long life Withstand 45g vibrations	119

OLD RANGES	REPLACEMENT TYPES	OLD RANGES	REPLACEMENT TYPES	OLD RANGES	REPLACEMENT TYPES
FELSIC 125	FELSIC 125 FRS	CELLSIC	FELSIC HC 10, 16 V	RELSIC TFRS [CO 43]	SICAL CO 42
FELSIC TFRS [CO 45]	FELSIC 105 TFRS (BC) [CO 45]	CMF FP - CMF	SICAL CO 42 - SICAL	SICAL 025 [CO 25]	SICAL CO 42
FELSIC HP	FELSIC 105 77 x 220	CMF FRS 12.3	SICAL CO 42	SICAL 041 [CO 41]	SICAL CO 42
FELSIC IND (BC - BD) 93.6, 94.6	FELSIC HC FELSIC 85 [BC - BD]	PROMISIC 015 [CO 15]	PRORELSIC 125 [CO 52] PROMISIC 031		
FELSIC UPS	FELSIC HC	PROMISIC 125 [CO 16]	PRORELSIC 125 [CO 52]		
FELSIC 018 [CO 18]	FELSIC 85 BC - FELSIC 039	PROMISIC FRS [CO 32]	SICAL CO 42		
FELSIC 019 [CO 19]	FELSIC 85 BC - FELSIC 039	PROMISIC TFRS [CO 28]	SICAL CO 42		
FELSIC DI	FELSIC 85 480 V - 500 V	PRORELSIC 105 TFRS [CO 48] [2]	PRORELSIC 125 [CO 52]		
FELSIC 036 [CO 36]	FELSIC 037 [CO 37]	RELSIC 026 [CO 26]	PRORELSIC 125 [CO 52] RELSIC 033		
FELSIC 038 [CO 38]	FELSIC 039 [CO 39]	RELSIC 125 [CO 44]	PRORELSIC 125 [CO 52]		

General technical data

1. BASIC CONSTRUCTION

Structure of an electrolytic aluminum capacitor is shown hereunder:



1. Anode: aluminum foil
2. Dielectric: aluminum oxide
3. Papers spacers impregnated with electrolyte
4. Ionic conduction assumed by electrolyte
5. Cathode: aluminum foil

The positive plate is an etched aluminum foil covered with alumina which is the dielectric of the capacitor.

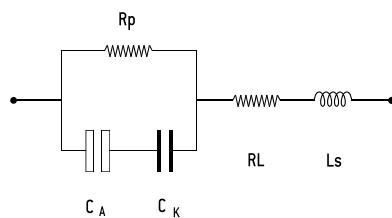
The negative plate is constituted by a second aluminum foil which serves as a current supply, and by electrolyte-impregnated papers layers.

The metal used for anode is a $\geq 99,98\%$ grade aluminum.

The dielectric has a thickness of $13 \text{ \AA} / \text{V}$.

The aluminum used for the cathode is a $\geq 98\%$ grade aluminum covered with a dielectric layer with a thickness of about 40 \AA .

2. DIAGRAM OF THE EQUIVALENT CIRCUIT



CA = Capacitance of the anode

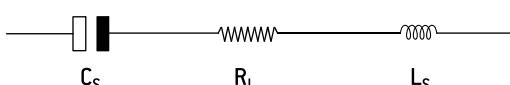
CK = Capacitance of the cathode

R_p = Parallel resistance due to the aluminum oxide films.

R_L = Series resistance of connections, plates and impregnated spacer.

L_s = Inductance of winding and connections.

A standard simplified diagram is:



C_s is the series capacitance of both anode and cathode capacitances. Electrolytic aluminum capacitors are naturally polarized because of the insulating film on the anode. Given the very thin aluminum oxide layer, a reversed voltage should not exceed 1.5 V when there is energy supply.

Short duration reverse voltages can be absorbed by special construction, second anode replacing the former cathode.

3. CAPACITORS MARKING

3.1. ARTICLE CODE (ON EACH PACKAGING)

A followed by 6 figures number. First 3 positions are specific of the range. (Ex. A 745xxx for a FELSC 85 BD)

140	FELSC in bank	741	FELSC 125 FRS BD (ex 731)
701	PROELSC 125	742	PROELSC 105 TFRS
703	PROELSC 125	743	PROELSC 105 TFRS
704	SNAPSIC	744	FELSC 85 BC FELSC 85 LP
705	SNAPSIC 105	745	FELSC 85 BD
706	FELSC HP BC - BD	746	FELSC 85 M BC
708	PROELSC 145	747	FELSC 85 M BD
710	CUBISIC	748	SICAL CO 42 - SICAL
711	PROMISIC 031	749	SICAL CO 42 - SICAL
712	CUBISIC LP	750	CUBISIC 125
713	SNAPSIC 105 LP	756	FELSC 105 BC FELSC 105 LP
714	SNAPSIC 4P	757	FELSC 105 BD
715	SNAPSIC 105 4P	760	FELSC HC BC
716	SNAPSIC HV	761	FELSC HC BD
717	SNAPSIC HC	762	FELSC 105 TFRS BC
718	SNAPSIC 125	763	FELSC 105 TFRS BD
721	RELSIC 033	764	FELSC HV BC
722	CI FRS	765	FELSC HV BD
723	CI FRS	775	VACSCIC
728	FELSC 039 (ex 727) FELSC DI	740	FELSC 125 FRS BC (ex 731)
738	FELSC 037 (ex 737)	774	VACSCIC 150
740	FELSC 125 FRS BC (ex 731)	776	ALSCIC 20G ALSCIC 145 20G

In FELSC ranges, article code without first letter A, is printed on each capacitor.

a Figure 9 in fourth position shows a special product.

3.2. BATCH (ON EACH CAPACITOR).

3 figures or 6 figures

3.3. DATE (ON EACH CAPACITOR IF APPLICABLE)

4 figures (year-week)

4. ELECTRICAL CHARACTERISTICS

4.1. RATED CAPACITANCE C_R

The rated capacitance is defined at 100 Hz and at ambient temperature.

4.2. RATED VOLTAGE U_R

U_R is the maximum DC voltage which may be applied in continuous operation.

When applying a superimposed alternating voltage, the peak value of the resulting waveform should not exceed the rated voltage.

4.3. PEAK VOLTAGE U_P

U_P is the maximum repetitive voltage which can be applied within short periods.

Defined in CECC 30 300 and IEC 60 384-4:

1000 cycles of 30 s charge followed by a no load period of 5 min. 30 s with upper category temperature.

$U_P \leq 1,15 U_R$ ($U_R \leq 315 \text{ V}$)

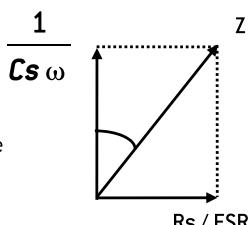
$U_P \leq 1,10 U_R$ ($U_R > 315 \text{ V}$)

General technical data

4.4. DISSIPATION FACTOR TAN δ

The dissipation or loss factor is defined by its tangent Tan δ

$$\text{Tg}\delta = \frac{R_s}{C_s \omega} \quad (\omega = 2\pi F)$$



ESR Capacitor Equivalent Series Resistance
C_s Capacitor capacitance
F Frequency (100 Hz)
Z Capacitor impedance

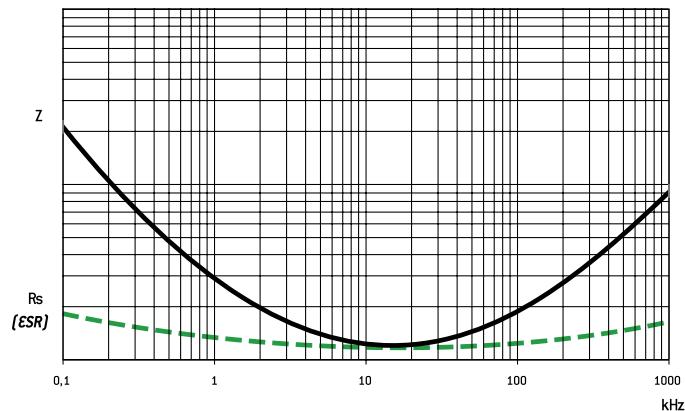
4.5. EQUIVALENT SERIES RESISTANCE ESR

The relation between ESR and dissipation factor Tan δ is given in § 4.4.

4.6. IMPEDANCE Z - INDUCTANCE L

The impedance is given by:

$$Z = \sqrt{R^2 + (L\omega - \frac{1}{C\omega})^2}$$



L inductance. Generally L = 5 to 20 nH

Z and ESR as function of frequency typically follows the chart:

4.7. PERMISSIBLE RIPPLE CURRENT (I r.m.s.) I~

The current is defined at the maximum climatic category and at 100 Hz. It is the root mean square value r.m.s. The value I₀ is the rated value for calculations of expected life up to 3 I₀.

4.8. LEAKAGE CURRENT II

I_l is measured at 20°C after a 5 min. polarization under rated voltage.

For C_R in μF and U_R in V:

$I_l \leq 0,01 C_R U_R$ or $1 \mu\text{A}^*$

when $C_R U_R \leq 1000 \mu\text{C}$

$I_l \leq 0,006 C_R U_R + 4 \mu\text{A}$

when $C_R U_R > 1000 \mu\text{C}$

For $U_R > 350 \text{ V}_{DC}$ it can be specified:

with K = 4, 6 or 8

or

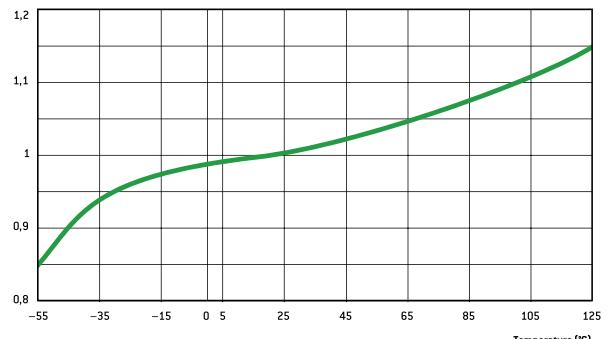
$I_l \leq 0,3 (C_R U_R)^{0,7} + 4 \mu\text{A}$ (CECC 30 300)

* Whichever is the greater

4.9. CHARACTERISTICS

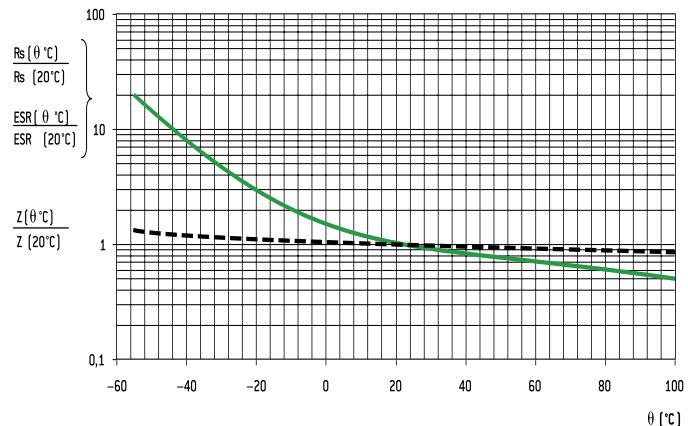
Versus temperature (typical values).

4.9.1. Capacitance drift



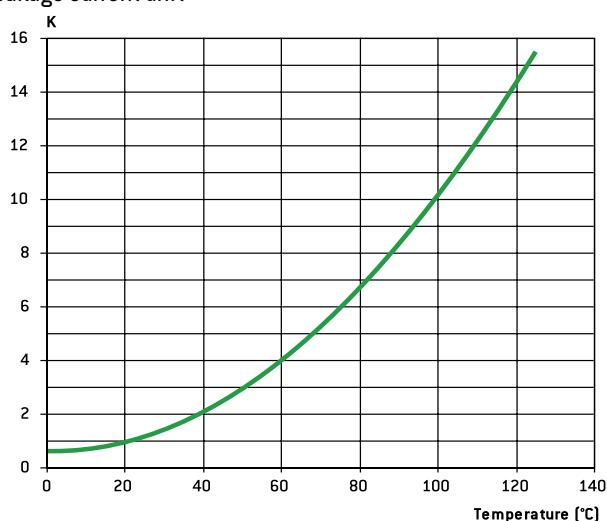
Versus temperature

4.9.2. ESR and Z drifts at 100 Hz



Versus temperature

4.9.3 Leakage current drift



Versus temperature

General technical data

5. SPECIFICATION TO APPLY

Electrolytic aluminum capacitors are defined in:

- NF and UTE French national standard
- CECC European specifications
- IEC international specifications

Quality insurance procedures are described in these specifications.

	French	European	International
Generic specification Fixed capacitors	NFC 83 100	CECC 30 000 EN 130 000	IEC 60 384-1 QC 300 000
Sectional specification Electrolytic aluminum capacitors	NFC 83 110	CECC 30 300	IEC 60 384-4 C 300 300
Blank data II specification - Electrolytic aluminum capacitors with non solid electrolyte.	UTE 83 110	CECC 30 301	IEC 60 384-4-1 QC 300 301
Blank data II specifications	CECC 30 301-017 to CECC 30 301-062 CO 31 to CO 55	CECC 30 301-017 to CECC 30 301-062 CECC 30 301-802 to CECC 30 301-811	

6. ENDURANCE TESTS / LIFE TIME

6.1. STANDARD ENDURANCE TEST

at max category temperature:

Standard endurance tests do not exceed 2000 hours at 125°C. However,

Temperature	Endurance test			
	Grade I - Long life		Grade II - General purpose	
	10 000 h	5 000 h	2 000 h	1 000 h
125°C			•	
105°C		•	•	•
85°C	•	•	•	•

present EXXELIA technologies concerning liquid electrolytes have led to endurance tests up to 5000 hours at 125°C [PRORELSIC 125 - FELSIC 125 RS] and even 20000 hours at 125°C [PRORELSIC 145 - ALSIC 145]

6.2. PERFORMANCE REQUIREMENTS ON STANDARD ENDURANCE TESTS.

Permissible capacitance drift $\Delta C/C [\%]$

Permissible increase factors on $\tan\delta$, ESR, Z and II initial values
(1) $\tan\delta$ or ESR: for initial value, take standard value.

U_R	Endurance test			
	Grade I		Grade II	
	10 000 h	5 000 h	2 000 h	1 000 h
6,3 V			+15-30	+25-40
10 V - 35 V	+15-20	± 15	± 15	± 30
40 V - 160 V	± 15	± 15	± 15	± 30
> 160 V	± 15	± 10	± 10	± 15
	Endurance test			
	Grade I		Grade II	
	10 000 h	5 000 h	2 000 h	1 000 h
Tan δ or ESR [1]	1,5	1,3	1,3	1,5
Z [2]	3	2	2	3
II	Standard values			

(2) Z: for initial value, take specified value (see data sheet).

Specific requirements can be taken into consideration with regards to initial values of dissipation factor or equivalent series resistance and impedance.

6.3. FAILURE CRITERIA FOR ELECTROLYTIC CAPACITORS.

Failure criteria are defined in CECC 30 301

- Non measurable defaults leading to complete failure.
- Measurable defaults leading to adjustment losses of the load circuit (failure due to variations).

6.3.1. Non measurable defaults.

They might be summed up as:

- Open circuit
- Short circuit
- Operation of pressure relief device
- Severely damaged insulation
- Unusable terminations

6.3.2. Measurable defaults.

Variations exceeding the values given below characterize a default.

- Capacitance drift $\Delta C/C [\%]$: 3 times the limit for standard endurance testing or 50 % (whichever is the smallest).
- $\tan\delta$ or ESR: 3 times standard max initial values.
- Z: 3 times standard max initial values.
- II: initial limit (under load conditions).

Specific requirements can be taken into consideration with regards to lower drifts.

6.4. INFLUENCE OF MAIN PARAMETER ON OPERATIONAL LIFE.

6.4.1. Temperature.

The capacitors operational life is highly dependent upon its internal temperature Θ_i and therefore upon the ambient temperature and the ripple current.

Knowing ESR and dissipated power values (§ 6.4.3.) one can figure out the internal temperature rise and then determine the capacitors expected life.

With present high boiling point electrolytes (§ 8.6)
 $\Theta_{i \max} = 125$ to 185°C depending on styles.

6.4.2. Ripple current.

The ripple current flowing through the capacitor increase the internal temperature through power dissipation.

Standards define the permissible current at 100 Hz and generally consider a temperature rise of 5 to 10°C of max category temperature.

Current waveforms and frequencies make it difficult to clearly determine the capacitors internal temperature rise, which defines the operationally life.

Experiments confirm following relationship:

$$\Theta_i = \Theta_a + (\Theta_c - \Theta_a) K$$

Where:

- Θ_i = Internal hot spot temperature
- Θ_a = Ambient temperature
- Θ_c = Case temperature
- K = Parameter depending upon case diameter and cooling
 $0 \geq 51 \text{ k} = 2^{\pm 0,5}$
 $0 < 51 \text{ k} = 1,5^{\pm 0,5}$ (air cooling - 0,2 m/s)

General technical data

r.m.s. value according to current waveform.

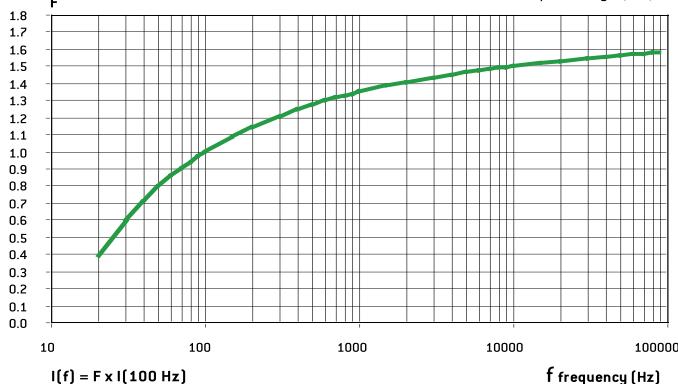
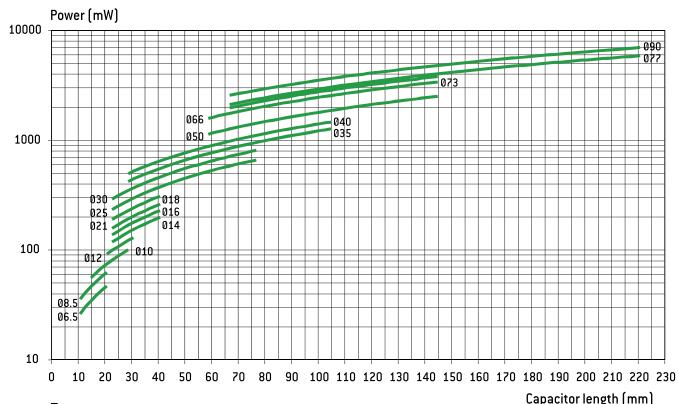
Function	Mean value	R.m.s. value
	$A [t_0/T]$	$A \sqrt{t_0/T}$
	$A [t_0/T]$	$A \sqrt{2t_0/3T}$
	$A/2 [t_0/T]$	$A \sqrt{t_0/3T}$

Function	Mean value	R.m.s. value
	$A/2$	$A \sqrt{3}$
	$2A/\pi [t_0/T]$	$A \sqrt{t_0/2T}$

Function	Mean value	R.m.s. value
	$2A/\pi$	$A/\sqrt{2}$
	$A/2$	$A/\sqrt{3}$

6.4.3. Dissipated power versus case dimension

For calculations of ripple currents, considering an internal



temperature rise of 10°C

$$P = \text{ESR} \cdot I^2$$

P = Dissipated power (mW)

$$(\Theta_i - \Theta_a = 10^\circ\text{C})$$

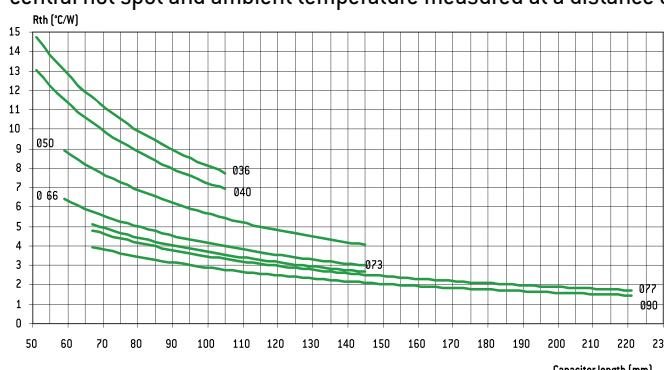
ESR: Equivalent series resistance (100 Hz 20°C)

I: Ripple current (r.m.s. value at 100 Hz)

For different frequencies from 100 Hz, I must be multiplied by the factor F, according to above chart.:

6.4.4. Thermal resistance R_{th} and air cooling

R_{th} is static thermal resistance (without cooling) between capacitor central hot spot and ambient temperature measured at a distance of



one capacitor diameter

Forced or not cooling air can lead to a significant decrease of these values.

Consequently, r.m.s. ripple current can be increased as a function of air cooling speed:

$\emptyset \text{ mm}$ (inches)	$\leq 0,5 \text{ m/s}$	1 m/s	2 m/s	3 m/s	$\geq 4 \text{ m/s}$
66 - 90	l~	1,1 l~	1,2 l~	1,25 l~	1,3 l~
36 - 51	l~	1,2 l~	1,4 l~	1,45 l~	1,5 l~

This parameter shall be applied to one capacitor alone.

For capacitors in bank, ambient temperature must be strictly equal around all capacitors.

6.4.5. Quality guaranty

We guarantee products manufactured during 2 years from the date of shipment against defaults of material and assembly.

This guaranty can be involved by the buyer only if our products are used within normal conditions, always according to the state of the art and taking in account storage conditions.

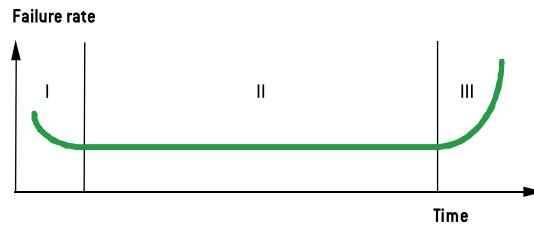
The equipment design should take into consideration possible failures of our capacitors and related effects in order to avoid them.

Guaranty is not applicable for damages occurred by surge voltage, irregular use, polarity inversion or maintenance default.

Guaranty is exclusively limited to the replacement of individual defective capacitors within the terms of delivery. This rule applied to all cases and particularly to any further consequence of failures.

6.4.6. Reliability

Failure rate:



$$FR = \frac{\text{Number of components tested} \times \text{test duration}}{\text{Number of failures}}$$

Failure rate is measured in FIT (failure in time = $10^{-9} / \text{hour}$).

The failure rate is set up during the life time of the capacitor (phase II).

I. Early failure phase (generally excluded during ageing process).

II. Operational life time of the capacitors

III. End of life

General technical data

Mean time between failures MTBF = 1/FR measured in years

Range	Failure rate for a failure percentage not exceeding 1% with a confidence level of 60 %
FELSCIC 85 >350 V FELSCIC HC > 350 V SNAPSIC - SNAPSIC HC > 350 V SNAPSIC 4P > 350 V PROMISIC 031 0 = 6,5 SICAL CO 42 - SICAL > 350 V	50 FIT - [MTBF = 2280]
FELSCIC 037 - 039 FELSCIC 85 ≤ 350 V FELSCIC HC ≤ 350 V CUBISIC CI FRS SNAPSIC 105 - SNAPSIC 105 4P SNAPSIC 105 LP - SNAPSIC HV SNAPSIC - SNAPSIC 4P ≤ 350 V SNAPSIC HC ≤ 350 V ALSCIC IR - ALSCIC 145 - ALSCIC HV - VACSCIC 150 - VACSCIC SICAL CO 42 - SICAL ≤ 350 V PRORELSIC 125 0 = 6,5 RELSIC 033 PROMISIC 031 0 > 6,5	25 FIT - [MTBF = 4560]
FELSCIC 125 FRS - SNAPSIC 125 FELSCIC HV - FELSCIC 105	10 FIT - [MTBF = 11410]
PRORELSIC 125 0 > 6,5 PRORELSIC 145	5 FIT - [MTBF = 22820]

Multiplying factor of FR with voltage and temperature

Factor	Temperature [°C]							
	≤ 40	50	60	70	85	105 (1)	125 (1)	145 (1)

[1] Only for permitted capacitors

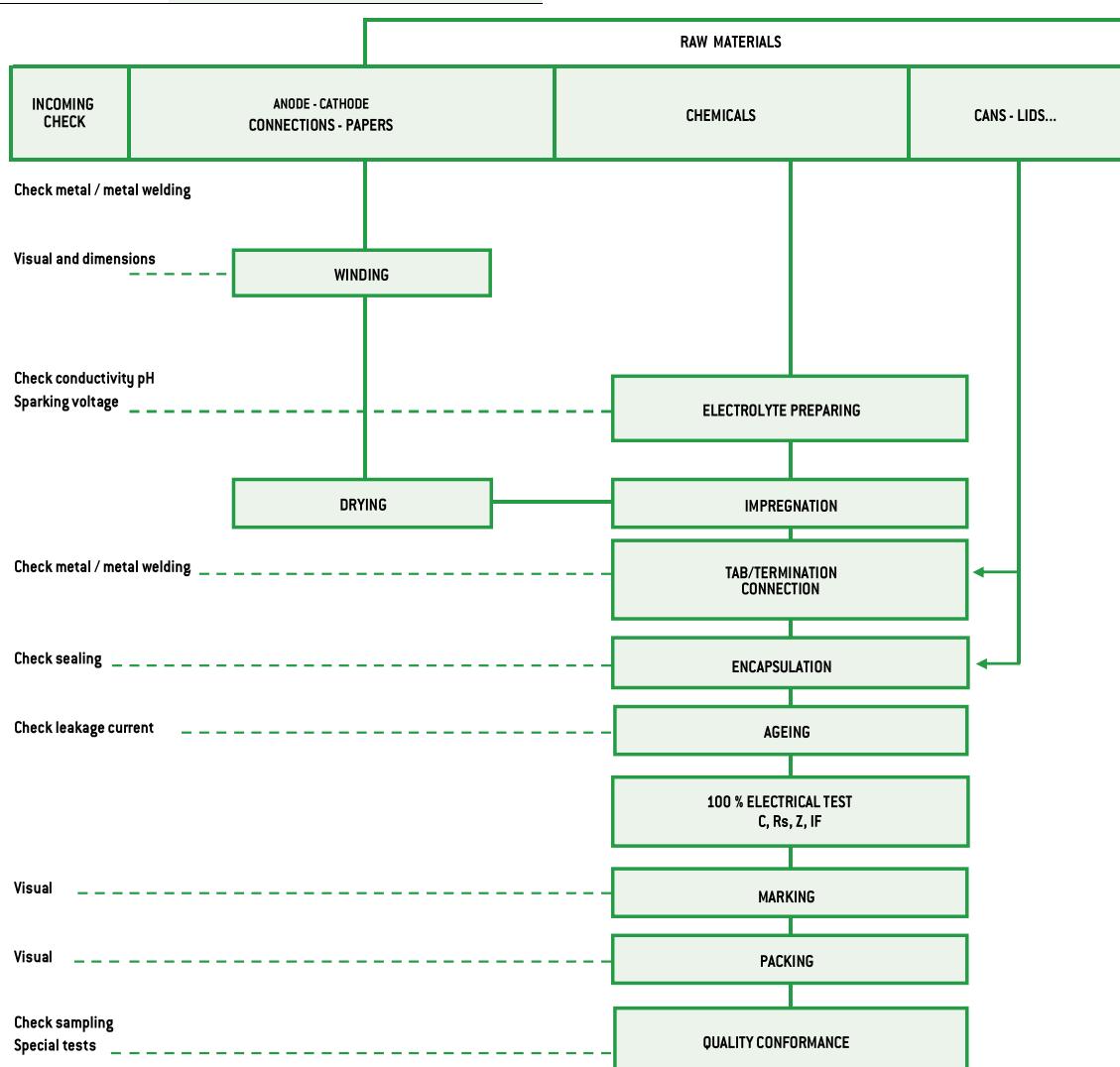
Factor	Percentage of rated voltage [2]		
	100 %	80 %	50 %

[2] This voltage has to be constant

Environment	Without vibration	Ground with vibrations or mobile				
	Ground, fix Controlled air	Ground, fix	PRORELSIC SNAPSIC 20 g FELSCIC 20 g	FELSCIC 10 g PROMISIC SICAL 0 ≤ 14	CI FRS - SNAPSIC RELSIC	ALSIC SICAL 0 > 14
Factor	1	2	2	4	6	12

7. MANUFACTURING FLOW CHART

Process controls



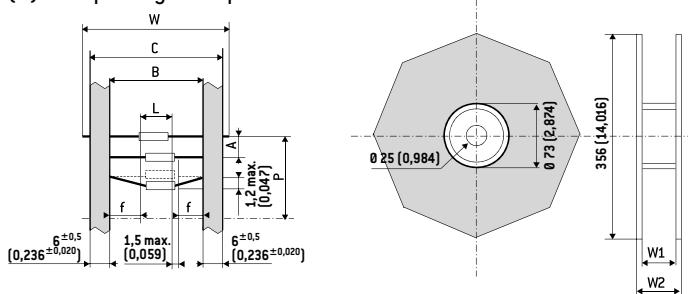
General technical data

2. PACKAGING ON TAPE

2.1. Axial types

Dimensions and tolerance in accordance with IEC 60 286-

(1) On tape only on request



DIMENSIONS in mm [inches]									
D	L max.	B	A	P	C max.	W ₁	W ₂ max.	W	n ⁽²⁾
6,5 [0,256] 8,5 [0,335] ⁽¹⁾	20 [0,787]	73 ^{±1,5} [2,874 ^{±0,059}]	10 ^{±1,5} [0,394 ^{±0,059}]	± 2 [0,079]	87,5 [3,445]	93 [3,661]	106 [3,661]	85 ^{±1,5} [3,346 ^{±0,059}]	1000 [39,370] 750 [29,528]
10 [0,394] ⁽¹⁾ 12 [0,472] ⁽¹⁾ 14 [0,551] ⁽¹⁾	32 [1,260]	73 ^{±1,5} [2,874 ^{±0,059}]	15 ^{±1,5} [0,591 ^{±0,059}]	± 3 [0,118]	87,5 [3,445]	93 [3,661]	106 [3,661]	85 ^{±1,5} [3,346 ^{±0,059}]	400 [15,748] 400 [15,748] 200 [7,874]

(2) n = number of capacitors per reel.

White positive tape f: > 20 mm (0,787 inches)

P: 10 space

SCREW TERMINALS

SCREW TERMINALS



FELSIC 85

CO 54 - CO 53

15 000 h / 85°C

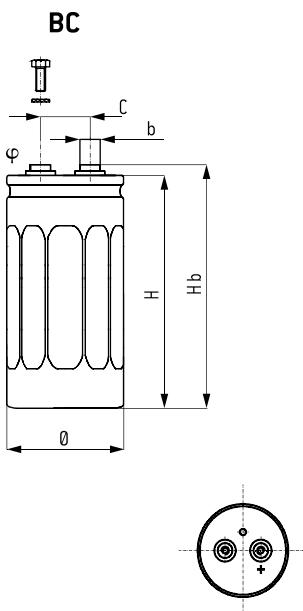
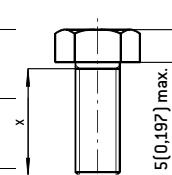
10 V ... 630 V

68 µF ... 680 000 µF

0 36 [1,417] ... 0 90 [3,543]

– 55°C +85°C

Long Life Time

**HEXAGONAL SCREWS mm (inches)**Screwing height between screws and terminals:
3,5 [0,138] maxMax. screw torque: M5: 3 Nm [x min 8 [0,315]]
M6: 6 Nm [x min 10 [0,394]]**SPECIFICATIONS**

NFC 83 110 - Long life

DIN 41 240 - Climatic category GPF – 55°C + 85°C / 56 days

CECC 30301-059 Issue 3

CECC 30 301-810

IEC 60 384.4 long life

Standard endurance test at U_R : $U_R \leq 350$ V: 5000 h / 85°C
 $U_R > 350$ V: 2000 h / 85°C**APPLICATIONS**

- Power electronics: converters, current inverters
- Switch mode power supplies
- Magnetization, welding machines, flash
- Circuit with high impulse current
- 360 V and 480 V series are mainly designed for repetitive fast discharges working.

Fixing: Clip or stud fixing

Screw terminals: M5 or M6

Tolerance on capacitance at 20°C : –10 +30 %

Operating temperature: – 55°C + 85°C

BC	BD
Insulated aluminum can	Aluminum can with sleeve
Hexagonal screws	Hexagonal screws
Spring washers	Spring washers
Fixing clip must be ordered separately	Stud fixing delivered with capacitor (steel hex nut, spring washer)

DIMENSIONS in mm (inches)

$\varnothing \pm 1$ [0,039]	$H \pm 2$ [0,079]	$H_b \pm 2$ [0,079]	$C \pm 0,5$ [0,020]	φ	b
36 [1,417]	52 [2,047]	58 [2,283]	12,7 [0,500]	M5	8 [0,315]
36 [1,417]	60 [2,362]	66 [2,598]	12,7 [0,500]	M5	8 [0,315]
36 [1,417]	80 [3,150]	86 [3,386]	12,7 [0,500]	M5	8 [0,315]
36 [1,417]	104 [4,094]	110 [4,331]	12,7 [0,500]	M5	8 [0,315]
51 [2,008]	81 [3,189]	87 [3,425]	22,2 [0,874]	M5	13 [0,512]
51 [2,008]	104 [4,094]	110 [4,331]	22,2 [0,874]	M5	13 [0,512]
66 [2,598]	104 [4,094]	110 [4,331]	28,5 [1,122]	M5	13 [0,512]
77 [3,031]	104 [4,094]	110 [4,331]	31,7 [1,248]	M5	13 [0,512]
77 [3,031]	144 [5,669]	150 [5,906]	31,7 [1,248]	M5	13 [0,512]
77 [3,031]	220 [8,661]	226 [8,898]	31,7 [1,248]	M5	13 [0,512]
90 [3,543]	144 [5,669]	151 [5,945]	31,7 [1,248]	M6	13 [0,512]
90 [3,543]	200 [7,874]	207 [8,150]	31,7 [1,248]	M6	13 [0,512]

\varnothing	d	I	Max. nut torque
36 [1,417]	M8	$12^{\pm 1}$ [0,472 ^{±0,472}]	4 Nm
≥ 51 [2,008]	M12	$16^{\pm 1,5}$ [0,630 ^{±0,059}]	10 Nm

RESISTANCE TO VIBRATIONS

Hb mm (inches)	>150 (5,906)	≤ 150 (5,906)
f [Hz]	10 – 55 Hz	10 - 2000 Hz
Amplitude	0,75 [0,030]	1,5 [0,059]
Acceleration	10 g - 98 m/s ²	20 g - 196 m/s ²
t [h]	3 x 2 h	3 x 2 h

WITHSTAND STRENGTH OF INSULATING SLEEVE

Insulation resistance at 20°C between terminals and mounting hardware: 100 MΩ

Test voltage at 50 Hz 1 min. between terminals and mounting hardware: 2000 V

Fire resistance: self extinguish 15 s (IEC 60 695-2-2)

FELSIĆ 85

CO 54 - CO 53

15 000 h / 85°C

PEAK VOLTAGE (V)

1000 cycles, without ripple current

Up: Repetitive standard peak voltage (30 s)

Us: Repetitive surge voltage (0,1 s)

Do not overstep this value without damage.

U _R	10 V	16 V	25 V	40 V	63 V	80 V	100 V	160 V	250 V
U _p	11,5	18	29	46	72	92	115	184	288
U _s							200	290	
U _R	350 V	360 V	385 V	400 V	450 V	480 V	500 V	550 V	630 V
U _p	385	390	424	440	495	500	550	605	695
U _s	405	405	430	450	500	540	600	650	700

PERMISSIBLE REPETITIVE PEAK CURRENT I_p:

If given corresponding max r.m.s. currents are not exceeded, peak current values are as follows:

DIMENSIONS in mm [inches]		I _p (A)		I~max.
Ø	H	40°C	85°C	(A)
36 [1,417]	52 [2,047]	400	200	22
36 [1,417]	60 [2,362]	450	220	22
36 [1,417]	80 [3,150]	600	300	22
36 [1,417]	104 [4,094]	700	400	22
51 [2,008]	81 [3,189]	800	400	25
51 [2,008]	104 [4,094]	1100	500	25
66 [2,598]	104 [4,094]	1900	800	50
?? [3,031]	104 [4,094]	3100	1200	55
?? [3,031]	144 [5,669]	4200	1800	55
?? [3,031]	220 [8,661]	5700	2400	55
90 [3,543]	144 [5,669]	5700	2400	80
90 [3,543]	200 [7,874]	???	3200	80

EXPECTED LIFE WITH ID:

- 1 to 5 discharges per minute For $I = I_d$ 48 000 000 cycles
In order to have the highest value of stored energy use preferably FELSIĆ 85 360 V.
- 10 discharges per minute For $I = I_d$ 36 000 000 cycles
- 15 discharges per minute For $I = I_d$ 18 000 000 cycles
 $I = I_d/2 > 1 \times 10^9$ cycles
- 15 to 60 discharges per minute
To have the highest dissipated power, use preferably FELSIĆ 85 480 V, 500 V and 550 V and calculate r.m.s. current (general technical data § 6.4.2.).

PERMISSIBLE RIPPLE CURRENT I (R.M.S. VALUE)

versus frequency f:

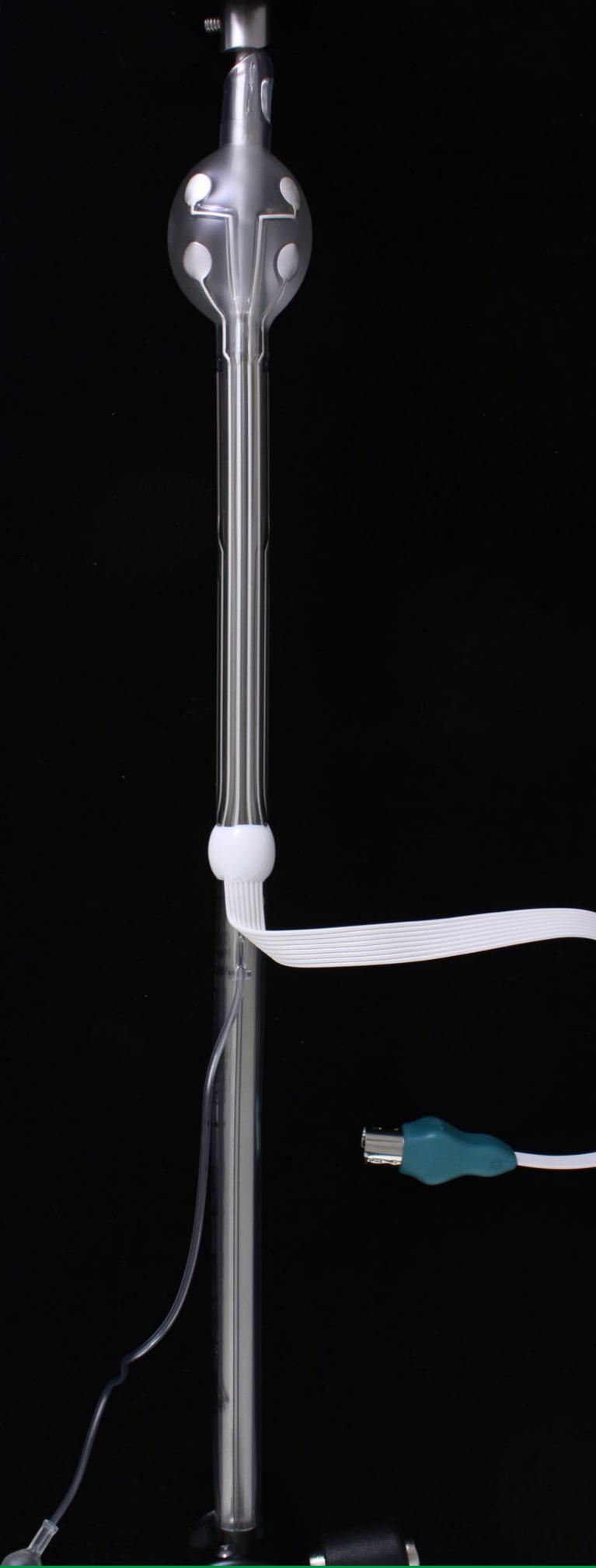
I~: permissible r.m.s. current at 100 Hz

f (Hz)	50	100	300	600	1 000	10 000	50 000
I	0,8 x I~	I~	1,2 x I~	1,3 x I~	1,35 x I~	1,5 x I~	1,6 x I~

FAST DISCHARGES WORKING (ID)Discharge current I_d = peak current of 3 ms per cycle of 1 to 60 s, at 40°C.

Id as a function of case

DIMENSIONS in mm [inches]		I _d
Ø	H	(A)
36 [1,417]	52 [2,047]	230
36 [1,417]	60 [2,362]	300
36 [1,417]	80 [3,150]	440
36 [1,417]	104 [4,094]	580
51 [2,008]	81 [3,189]	740
51 [2,008]	104 [4,094]	990
66 [2,598]	104 [4,094]	1400
?? [3,031]	104 [4,094]	2000
?? [3,031]	144 [5,669]	2800
?? [3,031]	220 [8,661]	3700
90 [3,543]	144 [5,669]	3900
90 [3,543]	200 [7,874]	4800



Introduction.

Traditionally passive medical devices are becoming smarter. Examples include disposable ETT and catheters and temporary implantables that would reside in the body for less than 30 days, all the way to permanent implant devices like orthopedic hardware and bone repair kits. Today, they are providing surgeons with functionality and data that even a decade ago would have been regarded as science fiction. This trend, however, poses a particular challenge to device designers: To increase functionality while keeping the device small and safe for the patient. Of course, this is especially important for any device that is implantable.

Exxelia Micropen has been involved in the development of many of these exciting devices. We are an organization with extensive expertise in developing, prototyping, and manufacturing medical tech. We have pioneering experience in direct write printed electronics technology, which we call Micropenning. Micropenning is an additive process (no wasted material) that writes fine-line conductive traces, sensors, and radiopaque markers directly onto a surface without the need for masks, appliques, or screens. What a decade ago might have been created with wires and attached sensors we can design today with printed electronics on the surface of the medical device substrate itself, thus adding desired functionality while saving valuable space and being safe for the patient. The printing can be done on just about any 3-dimensional shape and substrate with a variety of biocompatible inks to suit a particular requirement. The design can be configured to deliver heat, monitor vital signals, measure pressure, or other desirable properties.

How to determine if you should explore Micropen Direct Write additive printing.

1. Are you developing or modifying a medical device?

YES

NO

2.

- Do you need to add conductive traces, resistors, electrodes, radiopaque markers, or sensors to your device or subassembly?
- Do you need to pattern ultra-fine lines with narrow line widths and consistent thickness?
- Do you need biocompatible materials?

Not yet.

Call us at **(585) 624-2610** and we can help you get there.

At Exxelia Micropen we are offering endless solutions to fit the needs of our clients and partners. Visit **micropen.com** to connect with us and make your ideas reality.

YES

NO

3.

- Do you need expertise selecting the right materials for your application?
- Do you need a supplier that is ISO 13485 certified?
- Do you need rapid prototyping and manufacturing?

NO

YES

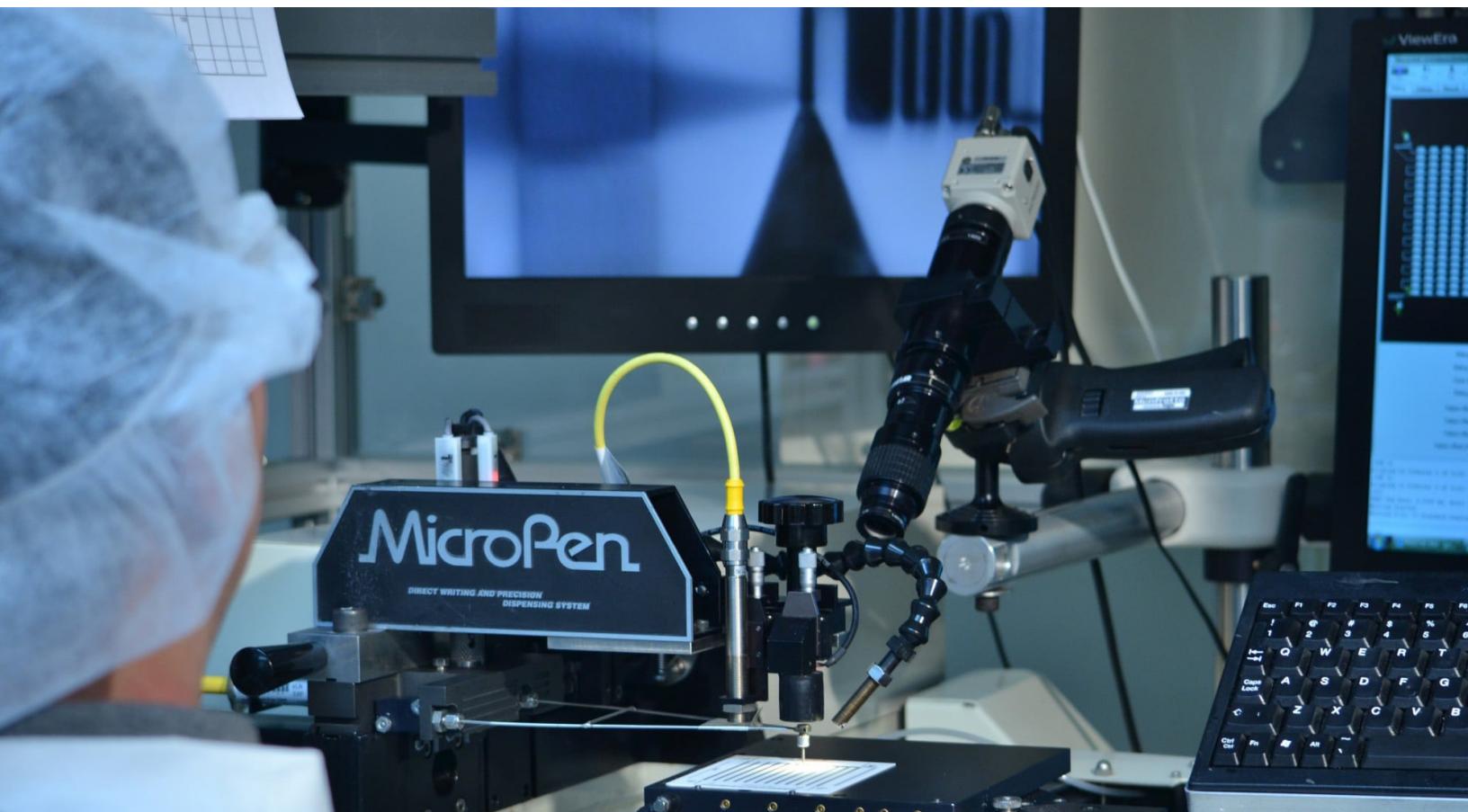
Next Steps.

A conversation with one of our engineers will help you. Visit **micropen.com/contact-us**

Medical device design considerations: wear, duration, prototype cost, production quantity, unit cost (at scale) and medical device certification

As you proceed along your development journey, these design considerations/parameters are all important.

- Of course, wear goes hand-in-glove with duration of the device as a key property for the design. Exxelia Micropen has experience with devices on every side of this scale, from disposable one-use devices to permanent implants designed for longer-term use.
- Prototype/development cost and speed of prototyping are strong points for Exxelia Micropen as our technology lends itself to rapid prototyping. Micropenning requires no screens, masks or appliques, which can be costly and time consuming to setup. Since it is an additive process, there is no material wasted, so Micropenning can represent a substantial cost savings when expensive materials (like gold) are required.
- Talking to us early can help us design your prototype with scale in mind, so there is no need for a major redesign once the prototype is approved.
- Exxelia Micropen is ISO 13495 certified with years of medical device manufacturing experience, which means we have highly stringent quality systems in place and the expertise to ensure a successful project.



5 criteria for a successful path to printing electronics on a medical device.

1

When considering a partner, do you sense their passion for quality?

Your design and manufacturing partner should have a culture throughout the entire organization of maintaining the highest level of quality. (It helps if they are certified ISO 13485, the medical device international standard for quality management.) This ensures that there are robust processes in place, from initial validation through qualification and production manufacturing. It also means that the organization can discover opportunities for improvement that can lead to greater efficiency and cost savings. Exxelia Micropen is certified as a contract manufacturer specializing in high-



precision electronic printing of critical functional materials of medical devices and components. The Micropen team is always looking for ways to improve on process and productivity.

2

Do they have relevant experience in medical device design, prototyping, and production?

There are complex requirements in the healthcare industry, and a proven track record in the understanding of proper documentation, revision control, and maintenance of device history records and safety regulations will go a long way to ensure that your project is successful. An experienced partner can provide advice on design, suitable inks, techniques, and steps to optimize the process. This can lead to valuable time and cost savings over the course of the project. There is no substitute for experience in partnering on the design and manufacturing of printed electronics for the implantable medical device market. Exxelia Micropen has over 25 years of experience in working with top-tier medical device companies, printing electronics on endotracheal tubes, ablation devices, balloon catheters, etc. Our engineering and development teams have the necessary technical expertise, and our production, test, and quality teams understand what it takes to manufacture volume devices while maintaining competitive pricing. We understand that we are adding value to devices that will be used to save or enhance a patient's life.

3

Could you envision them as a long-term partner and collaborator?

The most successful partnerships are long-term and collaborative. The resources on each team should have a shared understanding of the objectives and requirements, and the chosen supplier should be seen as an extension of your team. This allows challenges to be solved quickly and assures that the project will be completed on time and within budget. Regular meetings, passing files back and forth, and engaging experts in different functions of the organization are all elements of a partnership and lead to the success of the project. Your partner should be proactively communicating throughout the product lifecycle. Your partner may also consider investing in the partnership for the long-term. Over time, as you work together, you'll be able to apply learnings and efficiency to not only one product but a portfolio of products in a cost-effective and optimized way.

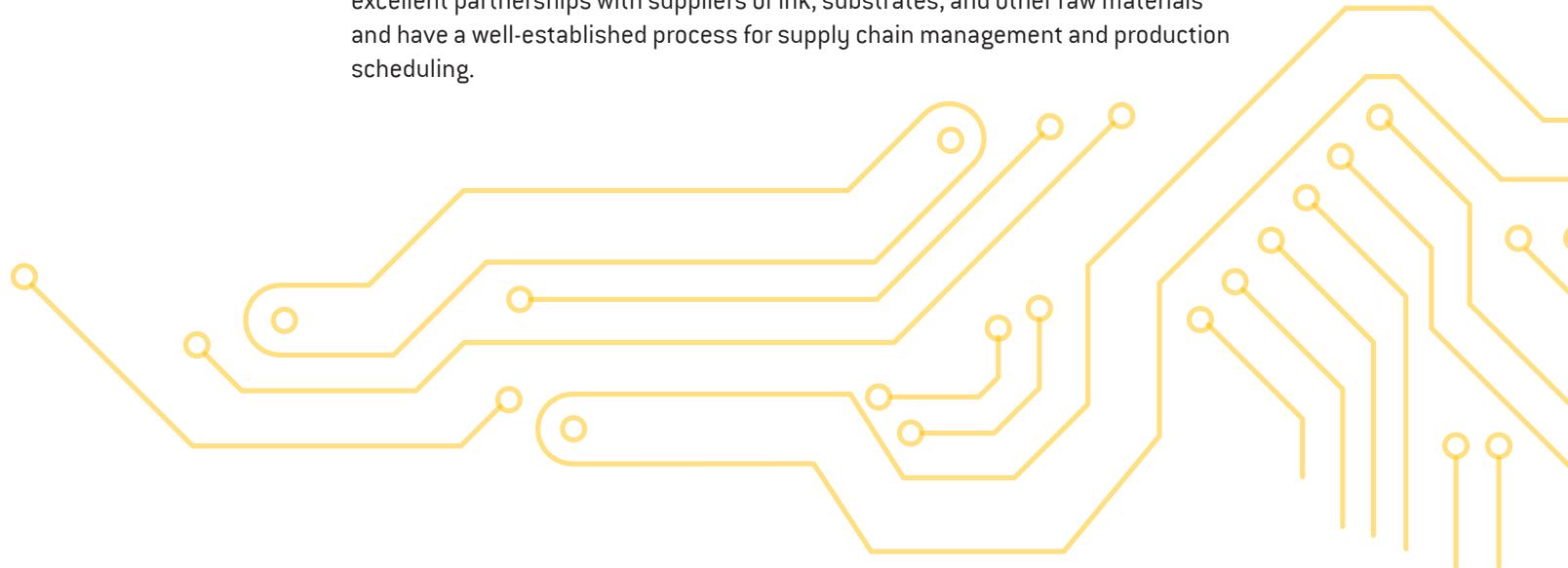
At Exxelia Micropen, we are committed to working collaboratively, starting early in the product design stage. We will share with you our accomplishments, manufacturing controls, and quality assurance process steps. We want you to get to know us, and the earlier we can engage with you as an integrated partner to your design team, the better. Most of our customers have been with us for years and we value a platform approach where we can apply our learnings to product extensions and next-generation designs.

4

Can they scale and respond to demand changes?

It is important to choose a partner who can meet your production requirements now and into the future. The manufacturer should be agile and flexible in regard to your demand changes and able to meet your deliveries as agreed. This requires that they have a well-understood supply chain of raw materials and lead times. Make sure to ask about this when selecting a partner. At Exxelia Micropen we have the resources and experience to respond to growth and demand increases.

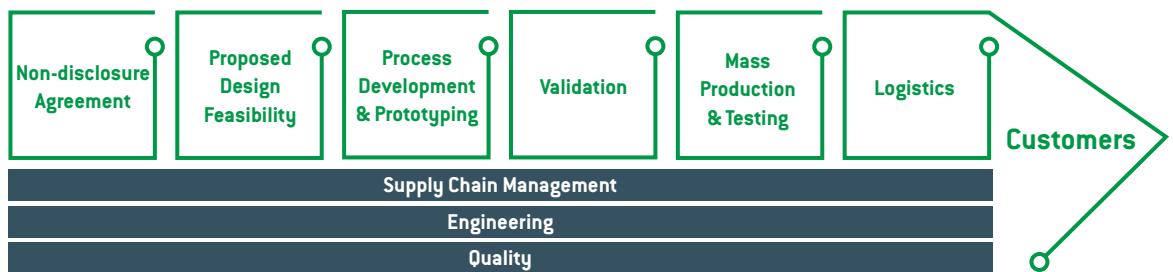
This is especially important in today's roller-coaster supply chain economy. We have excellent partnerships with suppliers of ink, substrates, and other raw materials and have a well-established process for supply chain management and production scheduling.



5

Do they have an end-to-end process?

A full-service partner who can collaborate on product design, rapid prototyping, manufacturing, testing, and supply chain services is ideal. Consolidating all activities under one roof can reduce costs and time to market. It also allows for problems to be addressed quickly and eliminates the finger-pointing when multiple suppliers are involved. You should choose a partner who will complement your own team, adding value end-to-end.



At Micropen we have expertise from design through manufacturing and responsive support throughout the product lifecycle. Our flexible printing manufacturing services can meet the needs of any company, from a start-up to a major OEM.

Why Exxelia Micropen?

Exxelia Micropen has been a pioneer in medical device development with Micropen printed electronics technology for 25+ years. We are ISO 13485 certified, and we have the expertise to collaborate with you end-to-end from initial design concept through production.

Links to Exxelia Micropen resources:

[Overview Video](#)

[Substrates & Inks](#)

[Medical Applications](#)

Contact Us:

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585-624-2610

micropensales@exxelia.com